

Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	20	V
Gate-Source Voltage			V_{GSS}	±12	V
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lo	2.8 2.3	А
	t<10s	$T_A = +25$ °C $T_A = +70$ °C	lo	3.1 2.6	Α
Continuous Drain Current (Note 6) V _{GS} = 1.8V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lo	2.2 1.7	Α
	t<10s	$T_A = +25$ °C $T_A = +70$ °C	l _D	2.4 1.9	А
Pulsed Drain Current (10us Pulse, Duty Cycle=1%)			I _{DM}	30	A
Maximum Body Diode Forward Current (Note 5)			Is	1.2	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		Po	0.43	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	296	°C/W
Thermal Resistance, Junction to Ambient (Note 3)	t<10s	$R_{\theta JA}$	252	°C/W
Total Power Dissipation (Note 6)	~ //\ Y	PD	0.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D. (178	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	Reja	151	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

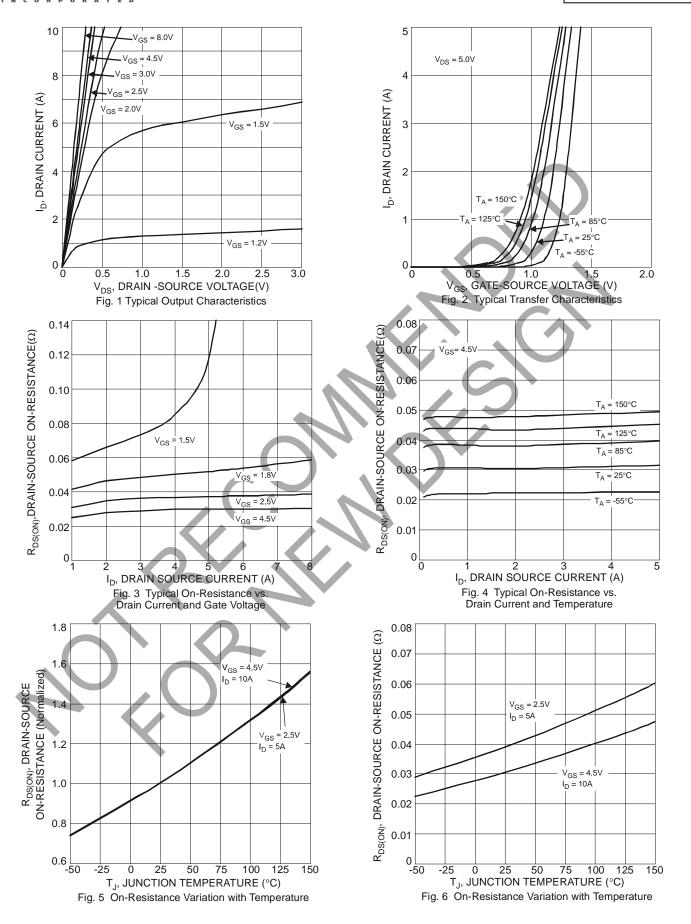
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	J		- 71				
Drain-Source Breakdown Voltage	BVpss	20	_	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current @T _C = +25°C	Ipss		_	1	μΑ	$V_{DS} = 20V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss	7	_	±1	μΑ	$V_{GS} = \pm 10V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	0.35	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		_	52	56	mΩ	$V_{GS} = 4.5V, I_{D} = 2A$	
Static Drain-Source On-Resistance	D. avanu	_	59	65		$V_{GS} = 2.5V, I_D = 2A$	
Static Drain-Source Off-Resistance	RDS(ON)	_	60	93		V _{GS} = 1.8V, I _D = 1A	
		_	75	140		$V_{GS} = 1.5V, I_{D} = 0.5A$	
Forward Transfer Admittance	Y _{fs}	_	7	_	S	$V_{DS} = 5V, I_D = 3.8A$	
Diode Forward Voltage	VsD	_	0.7	1.0	V	V _G S = 0V, I _S = 1A	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	Ciss	_	400.0		pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	73.8		pF		
Reverse Transfer Capacitance	Crss	_	65.6	_	pF	1 = 1.000112	
Total Gate Charge	Qg	_	5.4		nC	$V_{GS} = 4.5V, V_{DS} = 10V,$	
Gate-Source Charge	Qgs	_	0.7	_	nC	I _D = 6A	
Gate-Drain Charge	Qgd	_	1.4	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	3.5	_	ns		
Turn-On Rise Time	t _R	_	9.7	_	ns	V _{DD} = 10V, V _{GS} = 5V,	
Turn-Off Delay Time	tD(OFF)	_	23.8	_	ns	$R_L = 1.7\Omega$, $R_G = 6\Omega$	
Turn-Off Fall Time	t _F	_	7.2		ns	7	

^{5.} Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.







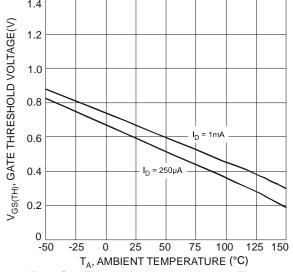
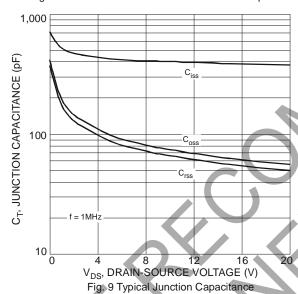
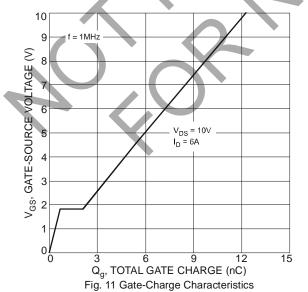
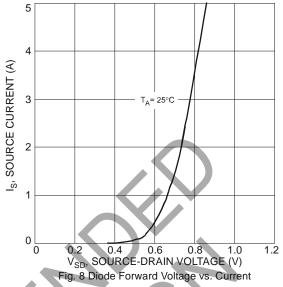


Fig. 7 Gate Threshold Variation vs. Ambient Temperature







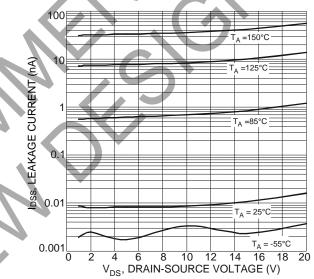
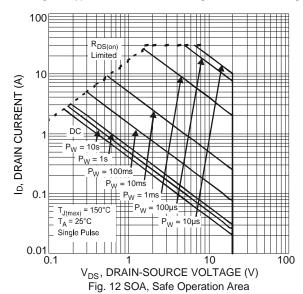
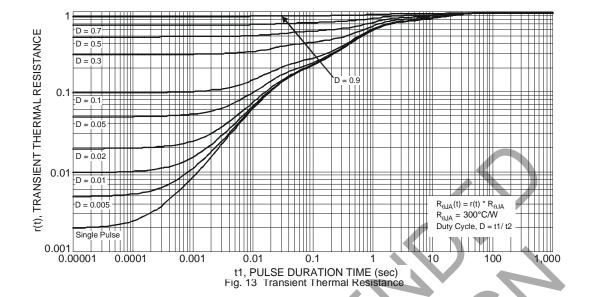


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage





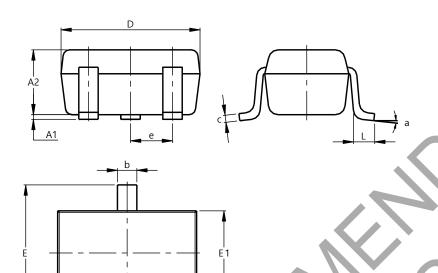




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

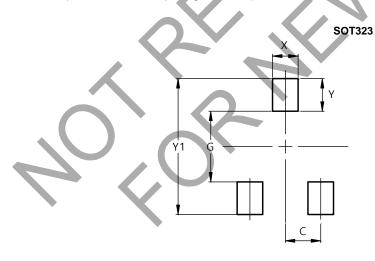
SOT323



SOT323					
Dim	Min	Max	Тур		
A1	0.00	0.10	0.05		
A2	0.90	1.00	0.95		
b	0.25	0.40	0.30		
v	0.10	0.18	0.11		
D	1.80	2.20	2.15		
Е	2.00	2.20	2.10		
E1	1.15	1.35	1.30		
e	e 0.650 BSC				
e1	1.20	1.40	1.30		
F	0.375	0.475	0.425		
۲	0.25	0.40	0.30		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
Х	0.470		
Y	0.600		
V1	2 500		



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